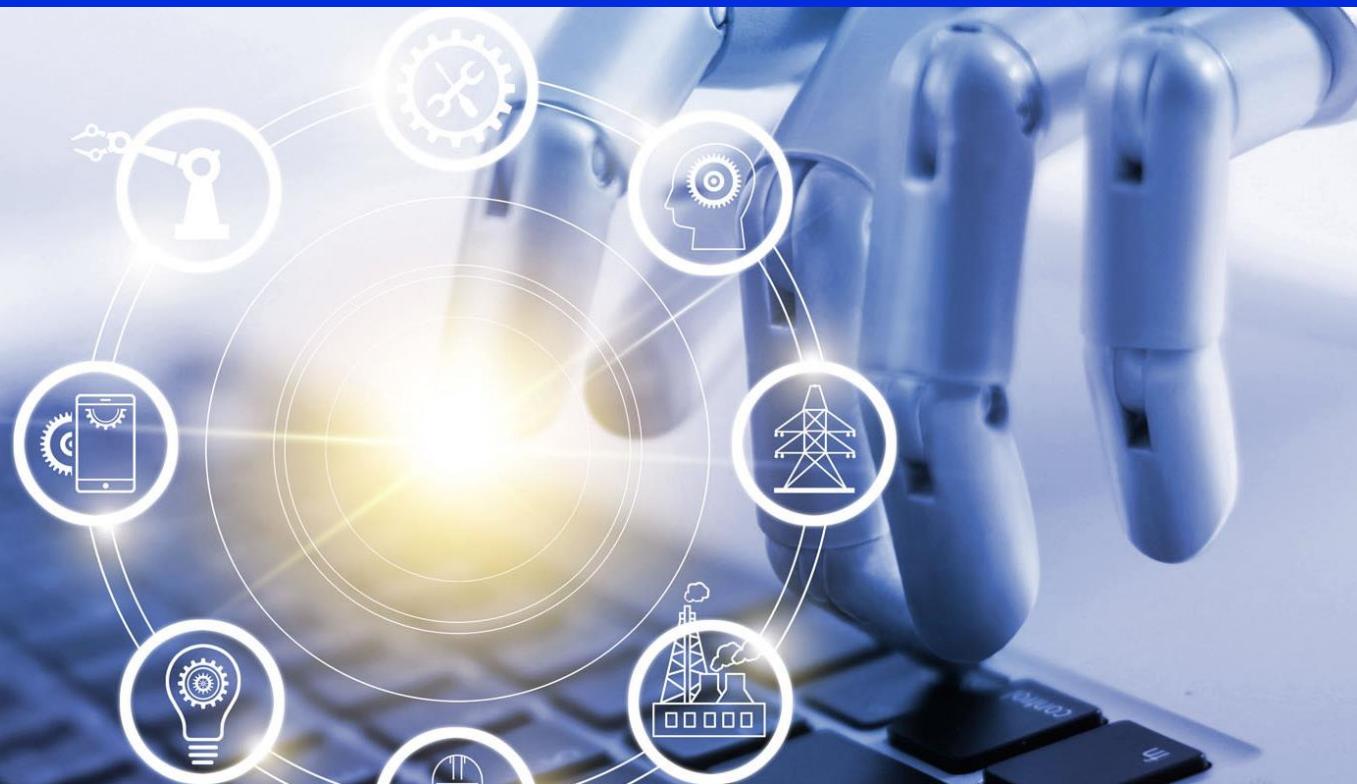


Amaya Igartua, Borja Coto, Iban Quintana, Cristina Monteserín, Jon Lambarri,
Borja Zabala, Iker Esnaola, TEKNIKER

Modeling Activities to optimize materials properties, processes and performance. Ontologies, Dissemination

Tekniker | EIBAR | 24/02/2021



Content

Materials and Product Optimization:

- Atomistic modelling and molecular dynamics **nanocomposites and nanopigments**,
- *Borja Coto* (borja.coto@tekniker.es ; Doctoral Thesis)
- Optimization of a **nebulizer** design, *Jon Lambarri* (jon.Lambarri@tekniker.es)

Process Optimization:

- Numerical modelling in **Laser** processing, *Jon Lambarri*
- **Cutting** operations, *Itxaso Cascón* (Itxaso.gascon@tekniker.es)
- **Curing** treatment, *Cristina Monteserín* (cristina.monteserin@tekniker.es, Doctoral Thesis)

Performance Optimization:

- Modelling **elastomers and Bearings** (Aitor Fernandez, aitor.fernandez@tekniker.es)
- **Moulds durability** in function of the type of failure modes, *Borja Zabala*
(Borja.zabala@tekniker.es; Doctoral Thesis)

Ontology

- OntoCommons Project, Iker Esnaola, iker.Esnaola@tekniker.es

Dissemination

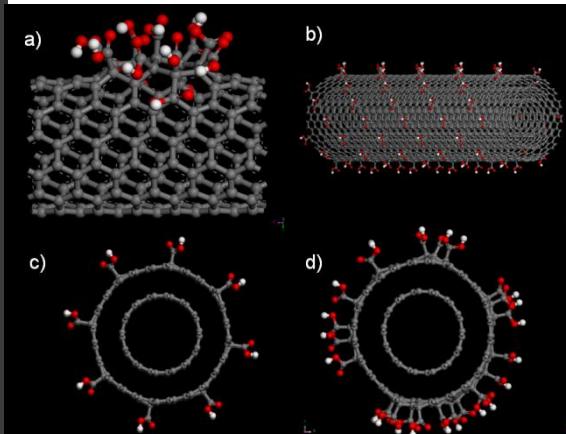
- EMMC 2021, 2-4 March

Materials Optimization: Polymer Composites Functionalization

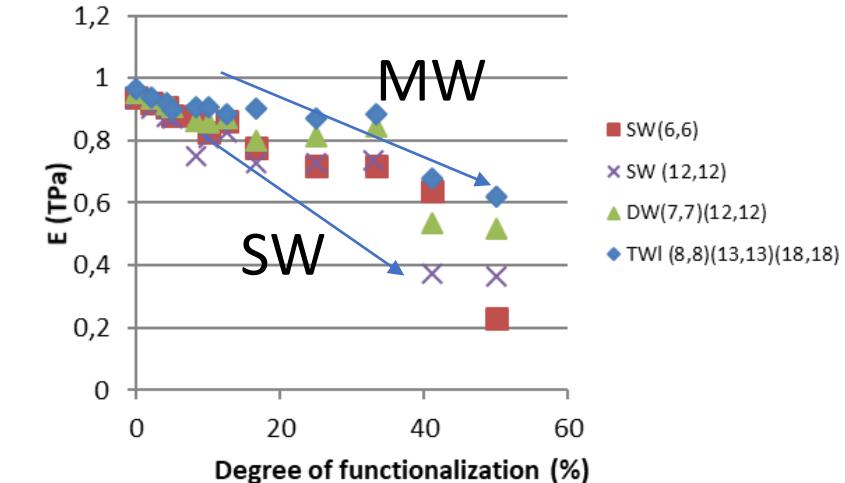


Objective: innovative polymer composites filled with CNT to obtain nanostructured materials

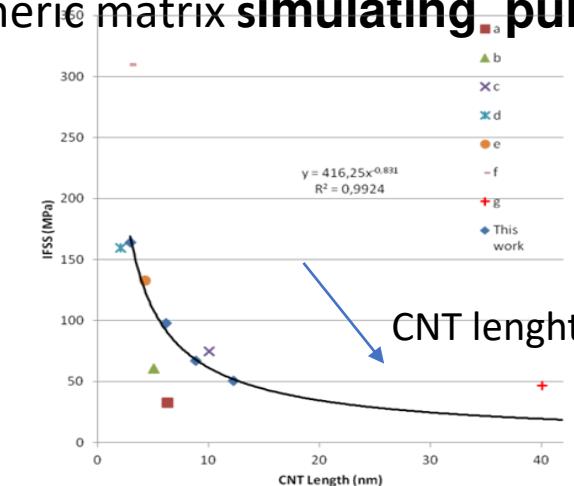
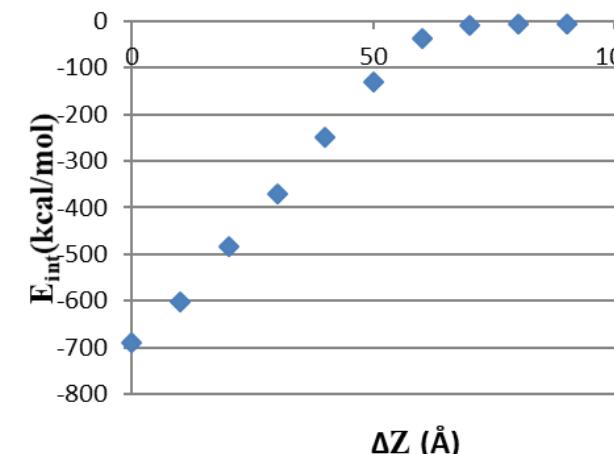
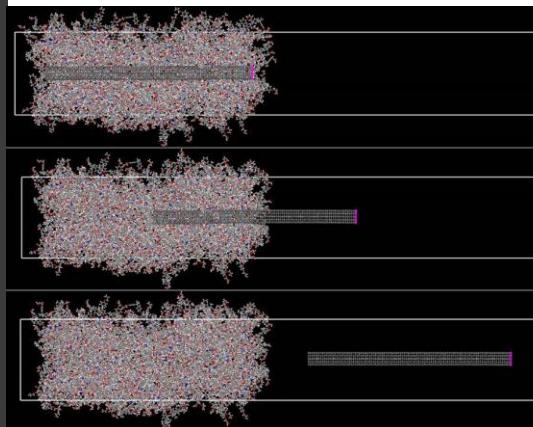
Modelling goal: Study the influence of functionalization on mechanical properties of CNTs. Modelling tool: MD (Acceleris, Materials Studio)



- Young's modulus **decreases** as % of functionalization **increases**.
- The decrease is less critical in MWCNT than in SWCNTs



- **MD modelling:** Interphase Interaction between CNT & polymeric matrix simulating pulling out of the CNT.



Interfacial Shear Strength vs Length of CNT.

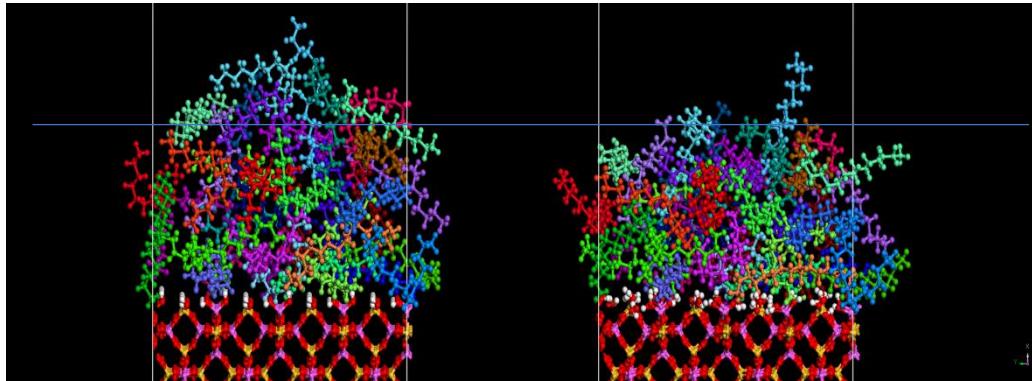


Materials Optimization: Absorption PCMs/Pigments

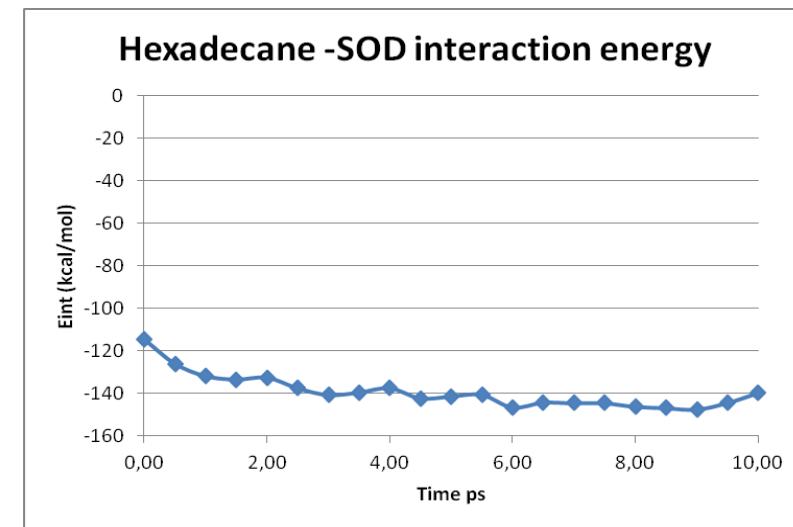


Project Objective: develop multi-functional and cost-efficient **ceramic nanopigments** for paint, plastic and concrete

- **Modelling Tools:** Atomistic Monte Carlo simulations to study absorption of molecules (PCM) in porous medium



Configurations of hexadecane molecules adsorbed on a surface
before and after 10 ps of MD run



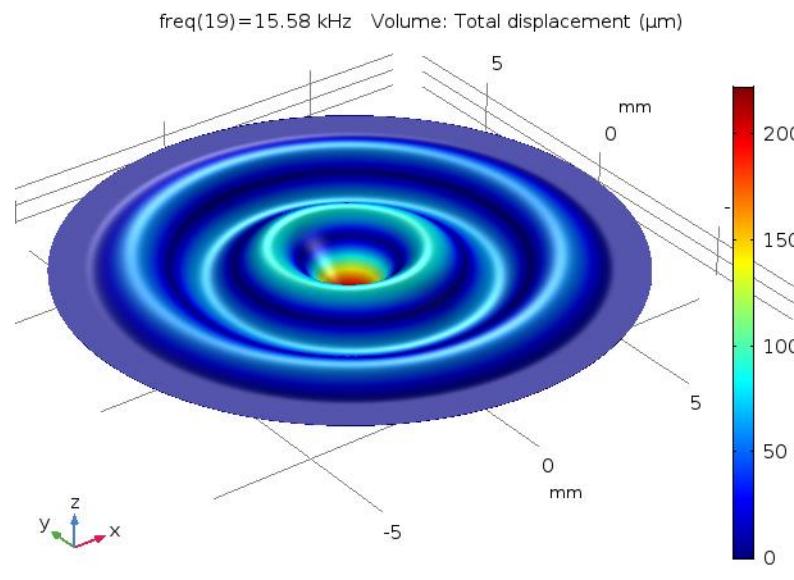
Evolution of the interaction energy between hexadecane
molecules layer and the SOD surface

- Evolution (10ps) of **adsorbed molecules** to determine their suitability to be adsorbed in a nano porous surface
- The MD simulation **show the stability** in time of the absorbed layer

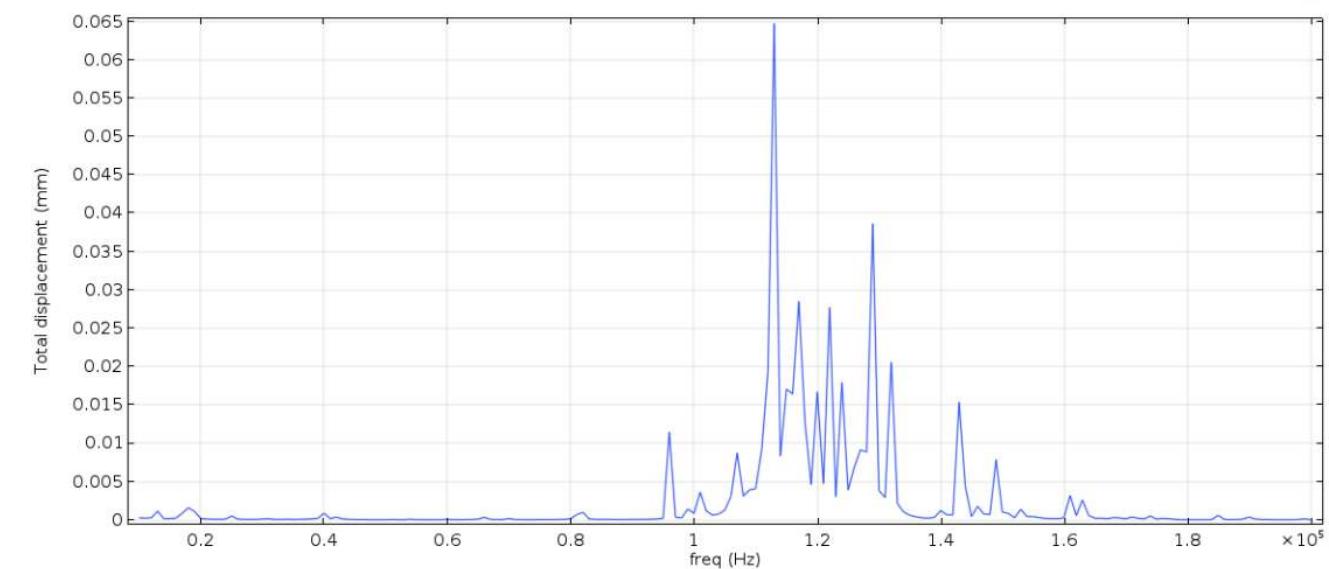
Product Optimization: Optimization of a nebulizer design



- **Objective:** Optimize a nebulizer design and find appropriate operation parameters
- **Modelling Tools:** Multiphysics COMSOL



Piezoelectric simulation of the membrane

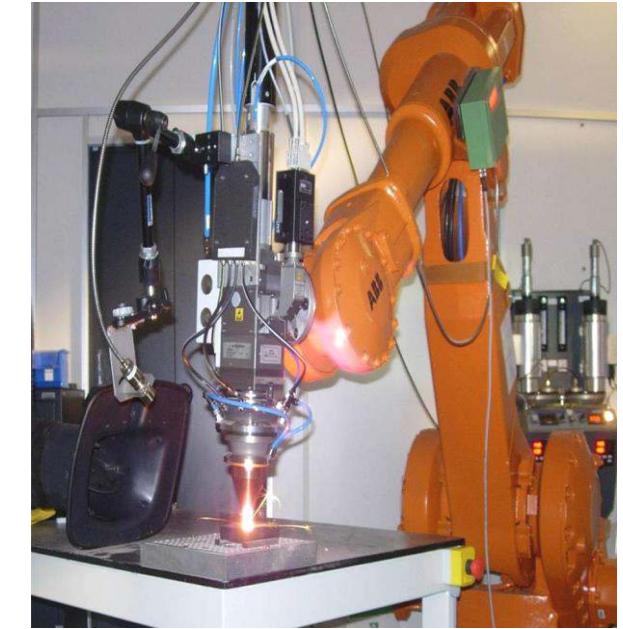
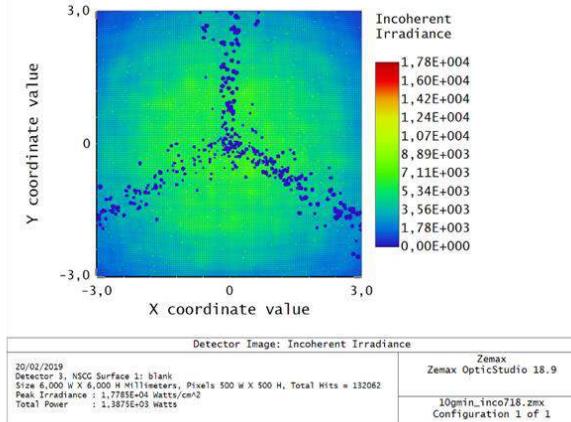
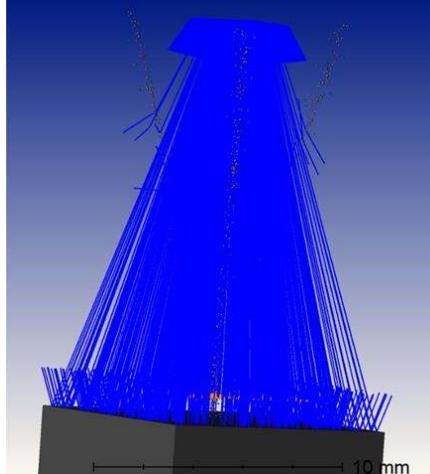
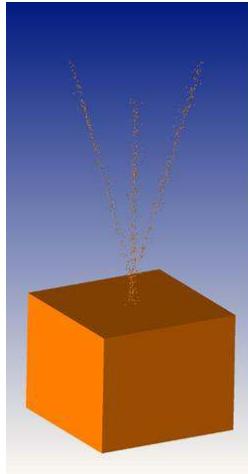


Output : Optimized geometry and frequency spectrum

The research leading to these results was carried out in cooperation with **LAINO MEDICAL**

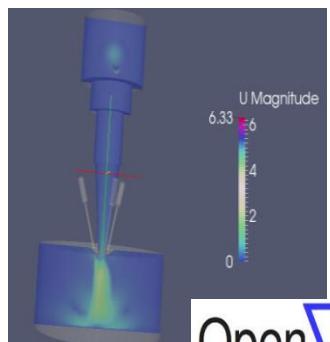
Process Optimization: Ray tracing during Laser Melting Deposition

- **Goal:** Study laser-matter interactions for laser additive manufacturing of metals to predict the thermal and mechanical response of the parts
- **Modelling Tools:** ZEMAX, OpenFOAM, SYSWELD

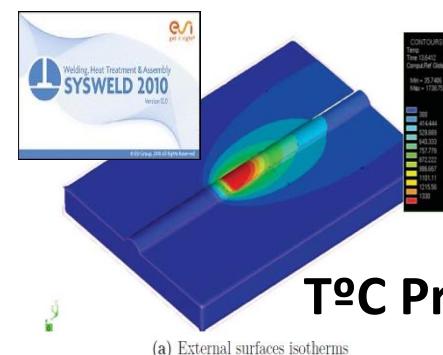


Import powder cloud Ray tracing from a laser source to the substrate

Output : Effective power density distribution for thermo-mechanical FEM simulation



OpenFOAM



T°C Processing



Deposited track geometry

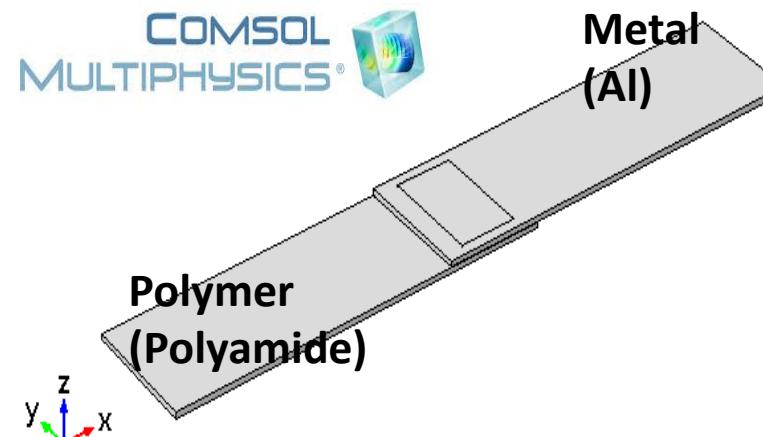
Process Optimization: Laser joining hybrid polymer-metal



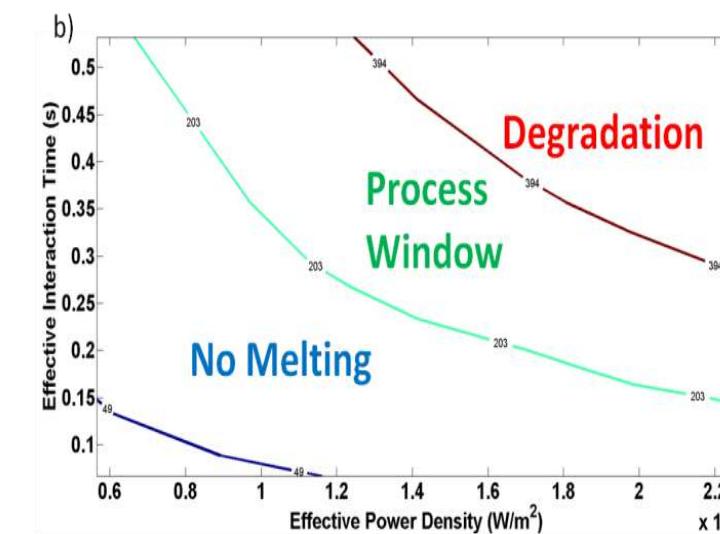
Goals: Obtain the process **parameter window** avoiding lack of melting or polymer degradation

Modelling tools: COMSOL Multiphysics

Applications: Hybrid components for lightweight structures



Test part configuration



Numerical parameter map



Funds from the European Union's Seventh Framework Programme (FP7/2007-2013) under grant agreement 309993. PM Join. **Partners:** Fraunhofer ILT, Faurecia, Valeo, PSA, Armines, Andaltec, Lasea, Tekniker

Process Optimization: Curing epoxy resins

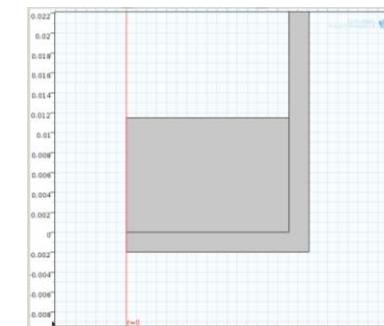
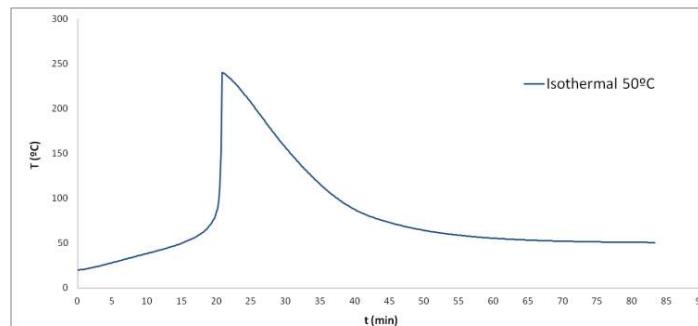
EMACOMP
project



Objective: to study the **curing kinetic** of an **epoxy resin** and the relationship between **the curing process parameters** and **final properties** of the thermoset networks

Modelling Tools: FEM Simulations, COMSOL, **Goal:** Coupling between **heat transfer & chemical kinetics**

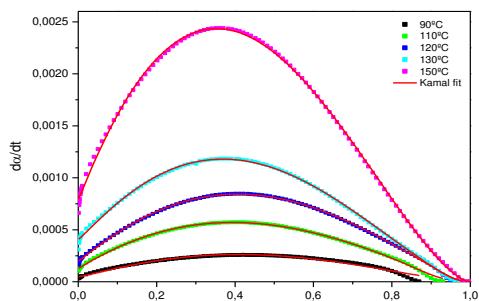
Objective	Impact
Curing evolution in a viscoelastic thermoset polymer resin	Increase process control
Predict and optimize curing cycles	increase process efficiency
Obtain high degrees of curing	Improve quality
Avoid heat degradation	increase durability
Reduce curing times	Reduce cost



Process Optimization: Curing epoxy resins



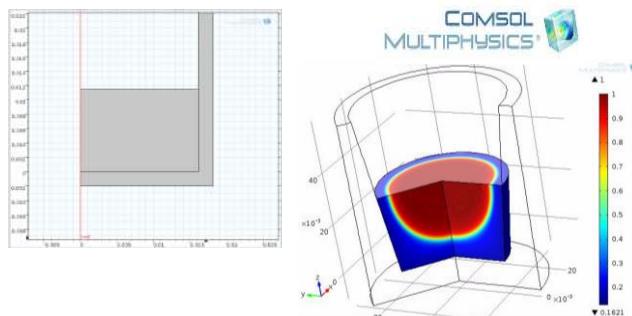
1. Thermal characterization of the curing kinetics



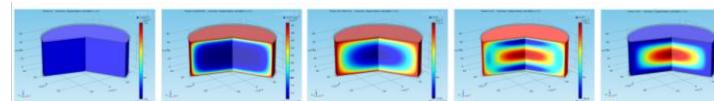
2. Obtaining of a **kinetic model** corresponding to the curing behaviour of a specific system (resin-curing agent)

$$d\alpha/dt = (k_1 + k_2 \alpha^m)(1 - \alpha)^n$$

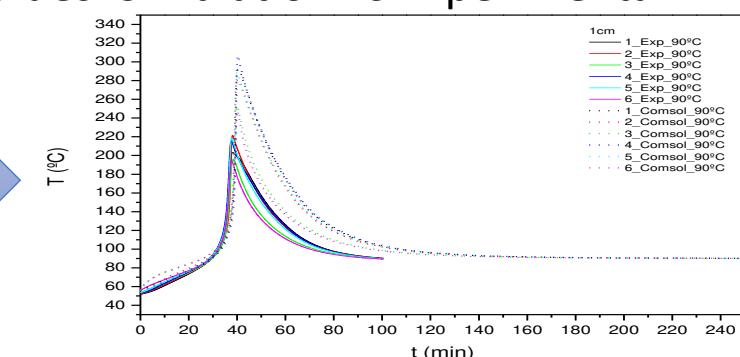
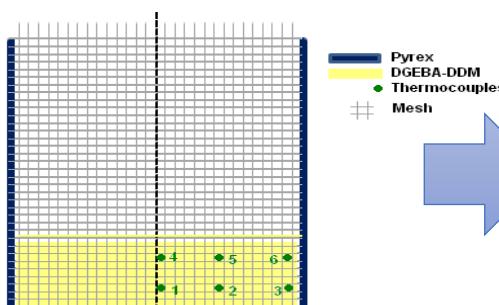
3. Simulation of a real piece, coupling chemical kinetics and heat transfer, using Levenberg-Marquardt **non-linear regression analysis**



Mapping **T^oC** and curing degree at any point and any time



Good correlation in T^oC values. Simulation **vs** Experimental

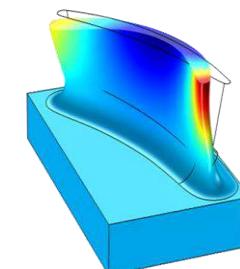
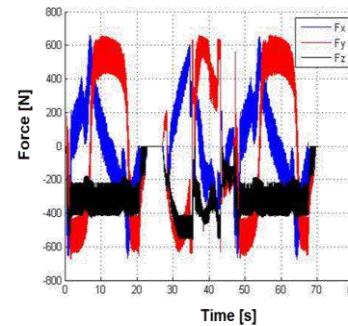
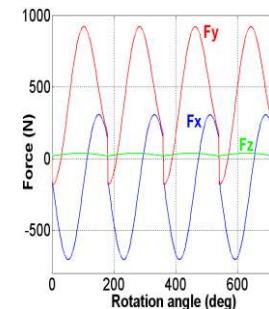


Process Optimization: Cutting and Machining



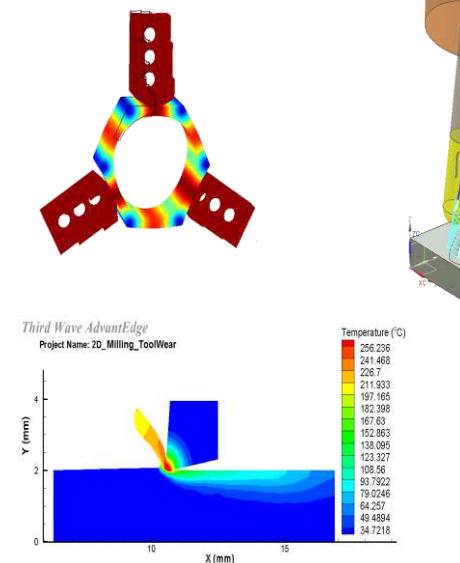
Objective/Impact: optimization of manufacturing processes. Models allows,
reducing the number of experiments and **reducing costs.**

- Cutting and machining
(Prediction of cutting force
 - stability (chatter and vibrations)
 - Material removal
 - **Surface finishing forecast**
 - CAD/CAM Integration
 - Chip formation (**mechanical & thermal effects**)
 - **Clamping distortion**

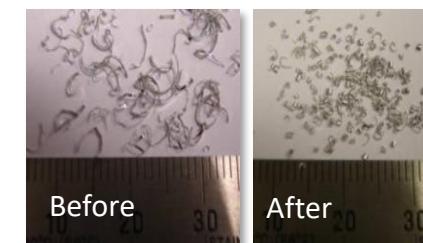
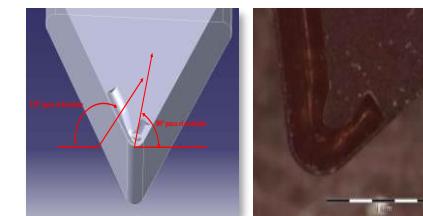


Design of a chip breaker

Better milling tooth paths

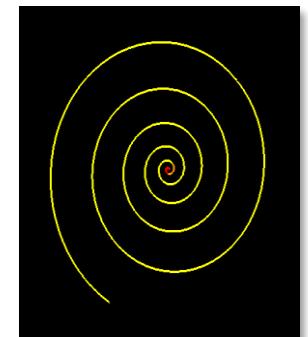
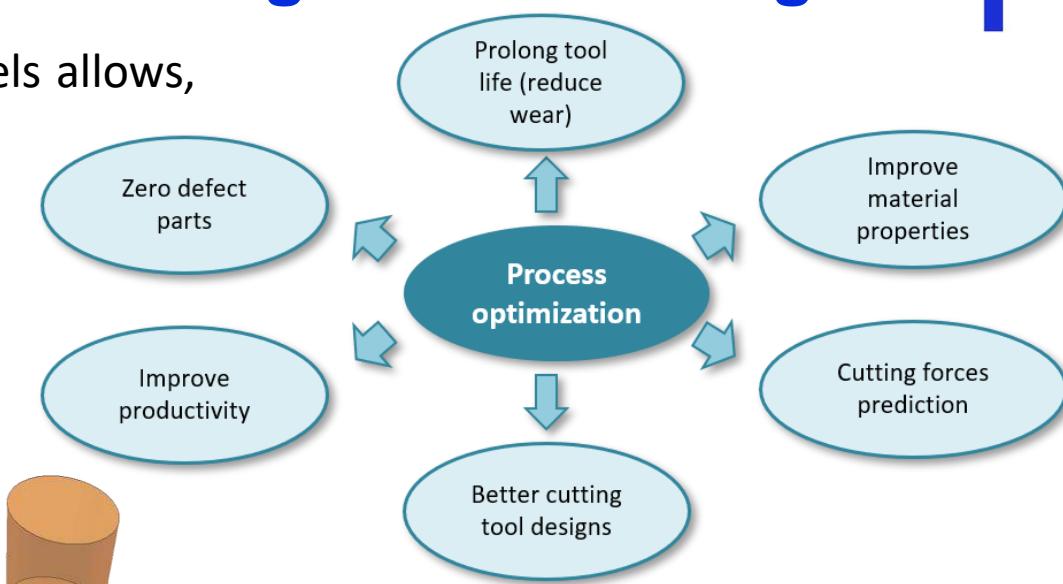


Design of a chip breaker



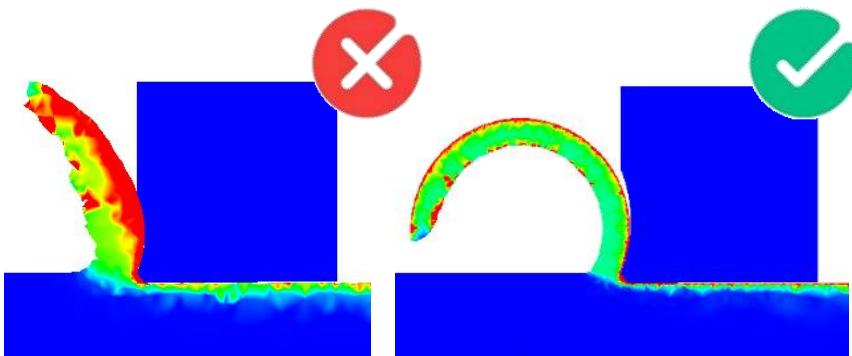
Before

After



Objective: Design of chip-breakers geometry by FEM simulation

Modelling Tool: Advantage



Cutting force = 197.4 N
Temp = 198,7 °C

Cutting force = 124.5 N
Temp = 170.6 °C

1 Without CB 2 With CB



+ Laser Additive manufacturing of the chip-breaker

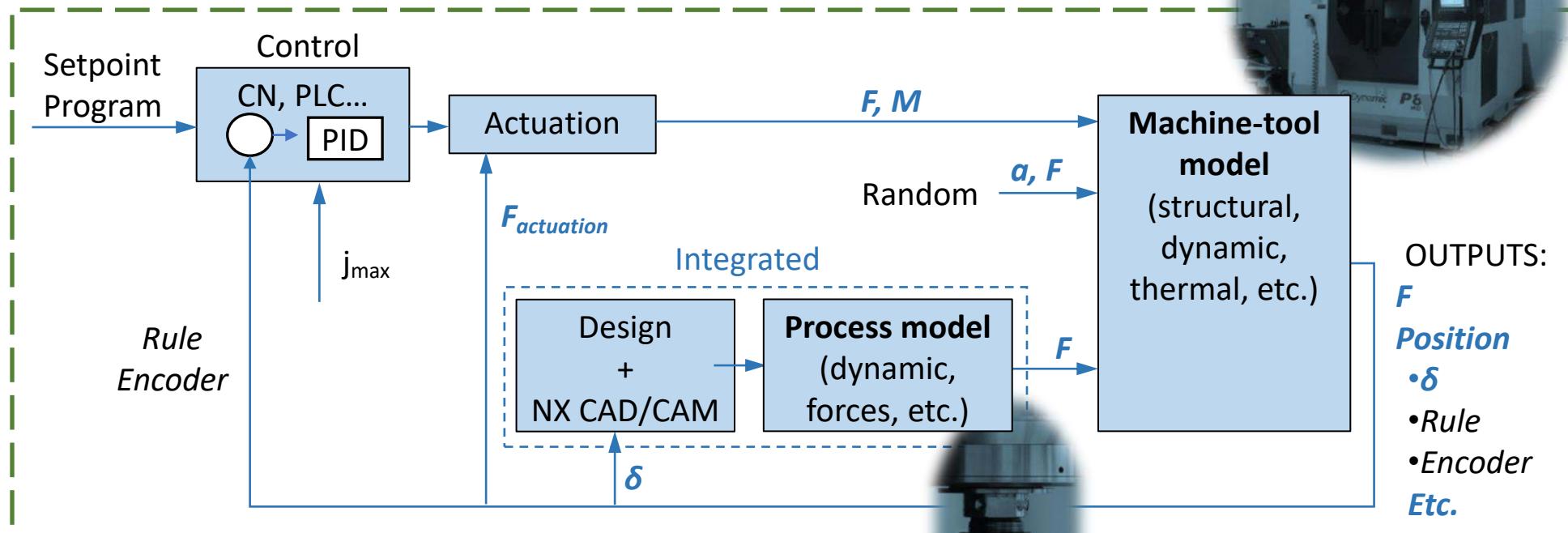
Turning of ductile materials (i.e. aluminium)

Process Optimization: Model integration & control



Modelling Tools: Matlab, Phyton

Machining modelling

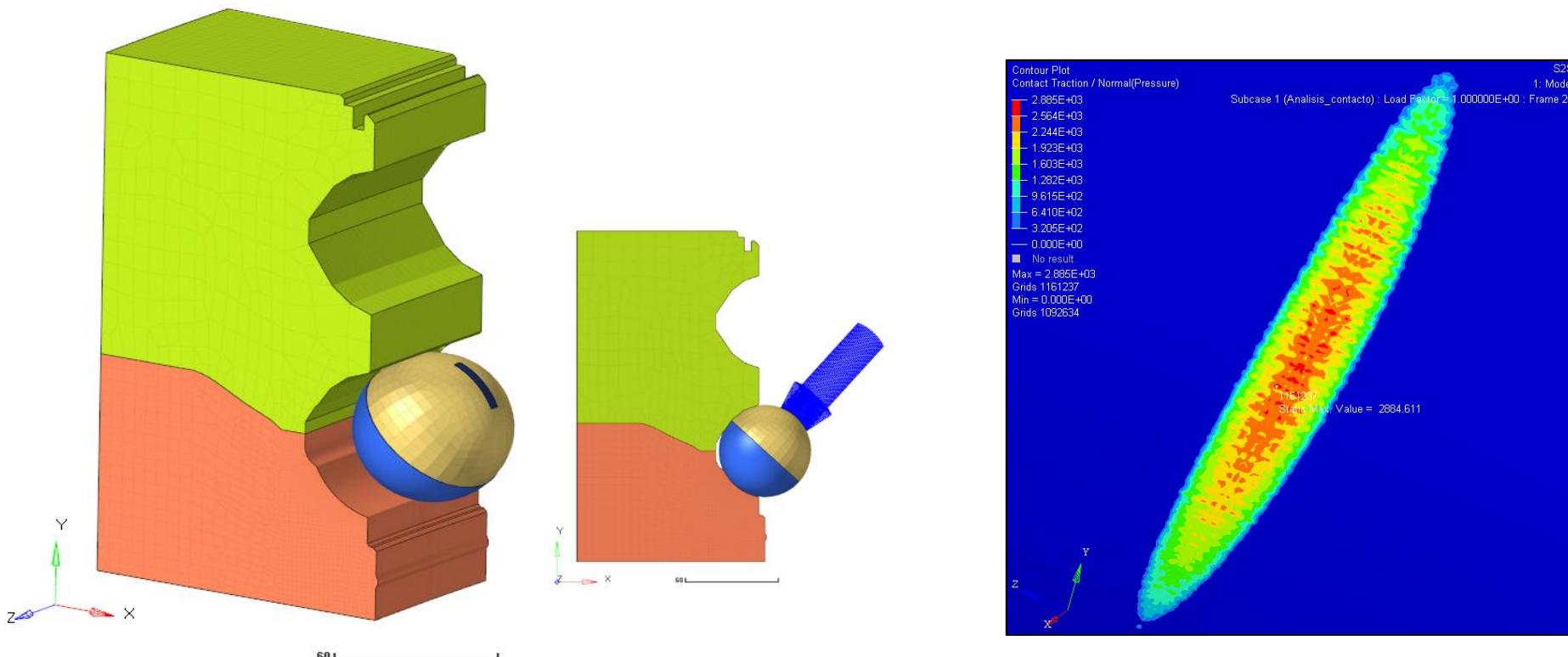


SMAPRO Project (Elkartek), Basque Country

Performance Optimization: Modelling Ball Bearings



- Modelling tools (FEMS, KISSsoft, BEARINX)
- Calculation of the **contact pressure**, useful for the **prediction of different failures**: Rolling contact fatigue, false brinelling... (analytical formulas)

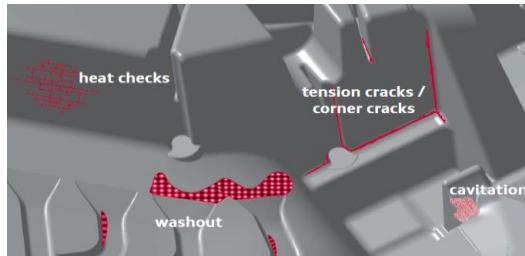




MODELING MOLD WEAR PERFORMANCE

THE FAILURE MECHANISM

- Thermal Fatigue
- Die Soldering
- Erosion
- Abrasion
- Corrosion



High Pressure
Die Casting

Plastic Injection
Molding

THE NEED

Example of Durability needs:

100-300.000 castings

Real durability:

5000-25000 cycles

Substitution cost of mold

insert: 50000€

Shutdown cost/day: 3000€

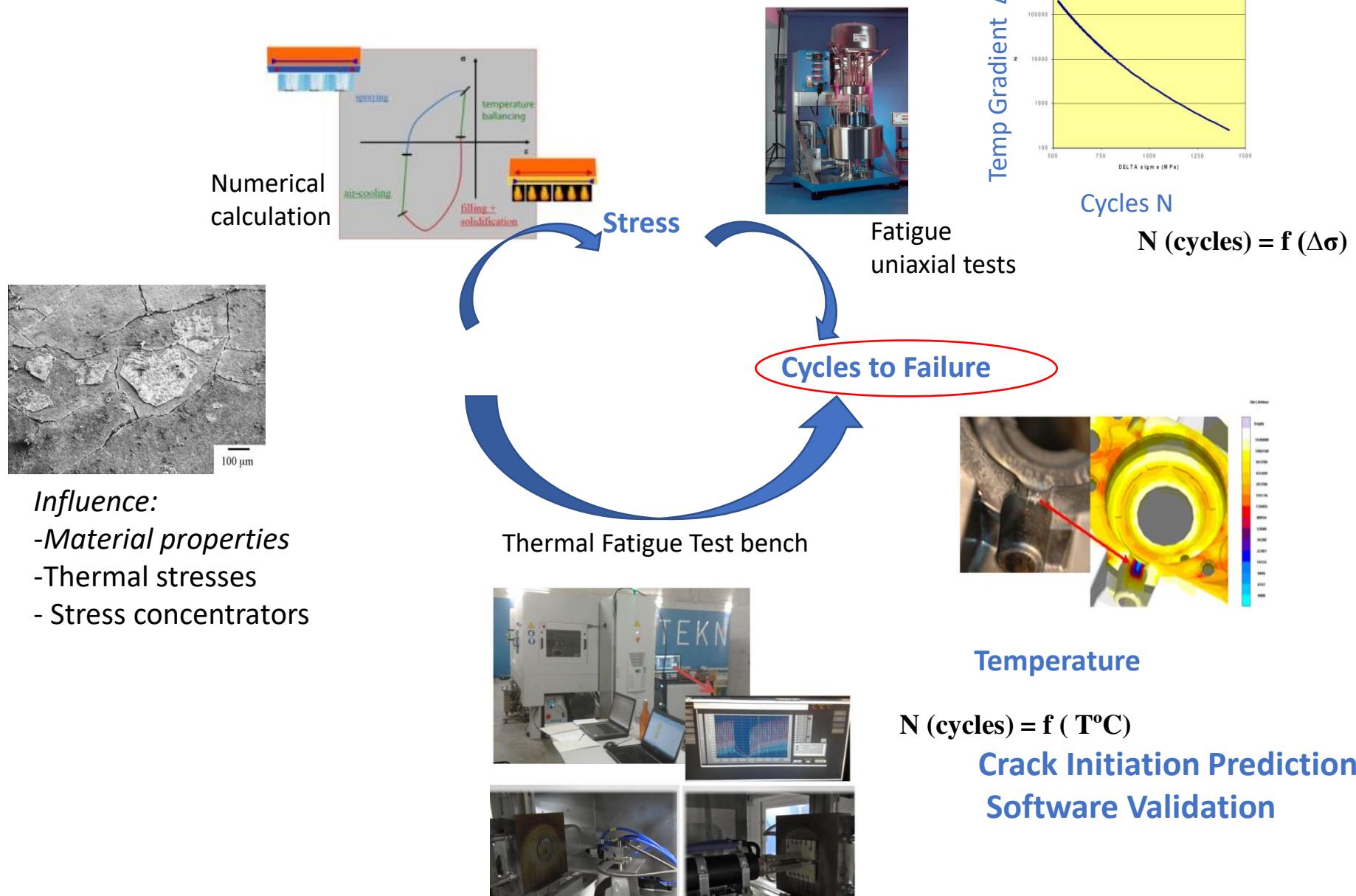


Financed by EU Commission Project Music: FoF-ICT-2011.7.1

Smart Factories: Energy-aware, agile manufacturing and customization



Performance Optimization: Modelling thermal fatigue





HPDC Example:

Thermal Fatigue

$$N \text{ (cycles)} = f \text{ (stress)}$$

Where

S: thermal stress calculated (820-920 MPa)

Die Soldering

$$N(\text{cycles}) = f \text{ (Temperature, pressure)}$$

Where:

T: Mould surface temperature (350 - 450°C)

P: Pressure in the mould surface (0 - 7 MPa),

K: depending on lubricant

Erosion

$$\text{Wear}(\mu\text{m}/\text{h}) = f \text{ (angle, speed, hardness)}$$

Where:

VEL: flux speed (32-64m/s)

ANG: impact angle (15-90°)

H: Hardness (200-900HV)

Reference case:

INPUT		
MaxT	400	°C
Thermal stress level	870	MPa
Pressure	1	MPa
Impact speed	50	m/s
Impact angle	30	°
Lubricant	2.68	D
Die material	1	H13

Failure prediction:

OUTPUT		
Thermal Fatigue	7369	Cycles
Die Soldering	956	Cycles
Erosion	17269	Cycles

Improved case:

INPUT		
MaxT	400	°C
Thermal stress level	820	MPa
Pressure	1	MPa
Impact speed	40	m/s
Impact angle	30	°
Lubricant	1	A
Die material	1	H13

Failure prediction:

OUTPUT		
Thermal Fatigue	18026	Cycles
Die Soldering	11286	Cycles
Erosion	30698	Cycles

time for mould reparation x 2

time for maintenance stops x 10

Ontologies, Onto Commons Project



OntoCommons Outputs

ONTO COMMONS TOOLS & SOLUTIONS

OntoCommons Ontology EcoSystem (OCES)

A hierarchy of ontologies
Toolkits
Specifications
OntoCommons Top Reference Ontology (TRO)
Top Level Ontology (TLO)
Domain Level Ontology (DLO)
Application Level Ontology (ALO)
Blueprinting reference implementation Toolkit
OntoCommons Ontology Repository
Ontology ecosystem knowledge graph

METHODOLOGICAL FRAMEWORK & ECOSYSTEM

- Methodological framework for ontology development and documentation
- Ontology ecosystem structure and reference implementation

REPORTS

- Data Management Plan
- Communities interested in domain-specific semantics
- Domains ontology requirements and specifications
- Feedback loops of cross domain ontologies interoperability
- The finalized Review of Domain Interoperability (RoDI)
- Dissemination, communication & stakeholder's engagement strategy & plan
- Exploitation & Sustainability
- Landscape of ontology development methodologies and platforms
- OntoCommons Standardisation Impact Report

EVENTS

- 2 DOMAIN ONTOLOGIES
- 2 HORIZONTAL WORKSHOPS
- 8 FOCUSED WORKSHOPS
- 2 EXPERT GROUP MEETINGS
- 3 EXTERNAL ADVISORY BOARD
- 6 SUPPORT WEBINARS

COMMUNITY

AN AUTHORITATIVE & ACTIVE EXTERNAL ADVISORY BOARD (EAB)
2,000 ENGAGED COMMUNITY MEMBERS FROM ALL STAKEHOLDER GROUPS & GLOBAL COVERAGE
PRESENCE AT >30 3RD PARTY EVENTS

DEMONSTRATORS

Use of Ontologies

- Airbus, Materials
- Bosch, Manufacturing of Microchips
- Aibel, Material, automated reasoning
- Teckniker, material, search and decision
- BASF, Material
- OAS, PSS on logistic and manufacturing, decision making
- IFAM, Material, quality management
- Manufacturing or chemical industry
- Holonix, Product life cycle management, manufacturing
- IRES, Nanosafety, manufacturing, decision making
- Adige SpA, Manufacturing, remote maintenance process

OntoCommons Stakeholder Groups

- **Scientific communities** in materials, chemistry, nanosafety, characterisation and manufacturing (e.g. NIST, IFAC TC5.3, IEEE, etc.)
- **Ontologists** in these fields (e.g. NCOR, and via IOF, RDA etc.)
- Materials and manufacturing **industries** (e.g. FIAT, DNV-GL, Total, SIEMENS, ABB, etc.)
- Associations and working groups in **ontologies** (IAOA, IOF, eCI@ss, ETSI-SAREF, etc.)
- Associations and working groups in **materials** (e.g. EMMC, EMCC, EUMAT, FAIR-DI, EPPN, Nanosafety Cluster)
- Associations and working groups in **data science** (e.g. RDA, EUDAT, BDVA, International Data Spaces Association)
- Associations and working groups in **manufacturing** (EFFRA, AIOTI, Intelligent Manufacturing Systems (IMS), plattform-i40, IOTA Foundation, ONEM2M, etc.)
- **Standards committees** (e.g. W3C, ISO/IEC JTC1, ISO/TC 184, IUPAC etc.)

See the [video](#) (ES)

If you would like to be part of OntoComons external expert Group: [Home | OntoCommons.eu](#)

CONCLUSIONS

The use of modelling to:

- Molecular Dynamic and Atomistic modelling to predict **properties at the nanoscale**
- **Piezoelectric simulation** has been used for product (nebulizer) design
- Optimization of **laser and curing processing** by modelling
- **Machining models** to improve the process, reduce the experimental set-up
- **New tool geometries** to reduce manufacturing errors.
- Use **FEM tools to predict failure** modes analytically and define tribological tests
- Prediction failure modes lifetime: constructing innovative equipment's, reproducing wear mechanisms, **building lifetime equations from experimental data**
- **Use a common ontology for modelling and data acquisition (OntoCommons)**
- **If you are interested in EMMC or OntoCommons, please tell us.**
- **Contact: Amaya Igartua (amaya.igartua@tekniker.es)**

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